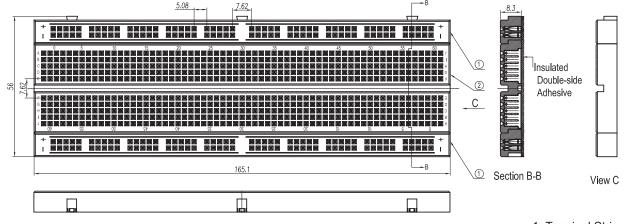
Breadboard / Solderless ABS

multicomp

3	Specifications:	
	Pitch	: 2.54mm
	Terminal Strips	: 630 Tie-point
	Distribution Strips	: 200 Tie-point
	Rated Voltage / Current	: 300V / 3 to 5A
	Insulation Resistance	: 500MΩ / DC500V
	Withstanding Voltage	: 1,000V AC / 1 minute
	Wire Range	: 29AWG to 20AWG
8	Temperature Range	: -25°C to +80°C
	Strip Length	: 7mm to 8mm



Dimensions : Millimetres

Terminal Strip
Distribution Strips

Part Number Table

Description	Part Number
Breadboard / Solderless, ABS	MCBB830

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